



#### 80V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Tc = +25°C
80V	3.9mΩ @ V <sub>G</sub> S = 10V	105A
	6mΩ @ V <sub>G</sub> S = 6V	87A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Switching
- Synchronous rectification
- DC-DC converters

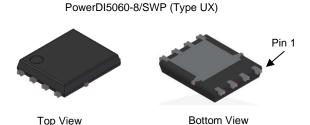
#### **Features and Benefits**

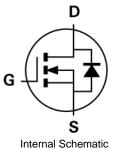
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH8003SPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

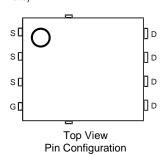
https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.097 grams (Approximate)







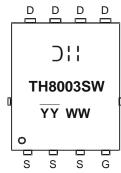
## **Ordering Information** (Note 4)

Part Number	Paakaga	Packing		
Part Number	Package	Qty.	Carrier	
DMTH8003SPSWQ-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**



Dil = Manufacturer's Marking
TH8003SW = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 24 = 2024)

WW = Week Code (01 to 53)

DMTH8003SPSWQ



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	80	V	
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 5)	T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	lD	105 75	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	420	Α	
Continuous Body Diode Forward Current (Note 5) T <sub>C</sub> = +25°C		Is	105	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	lsм	420	Α	
Avalanche Current, L = 3mH (Note 6)	IAS	15.8	Α	
Avalanche Energy, L = 3mH (Note 6)	Eas	375.4	mJ	
Avalanche Current, L = 0.1mH	las	65	Α	
Avalanche Energy, L = 0.1mH	Eas	211.4	mJ	

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 7)	P <sub>D</sub>	3.75	W
Thermal Resistance, Junction to Ambient (Note 7)		40	°C/W
Total Power Dissipation (Note 5)		99	W
Thermal Resistance, Junction to Case (Note 5)	R <sub>0</sub> JC	1.51	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	80	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 64V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	_	4	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	2.5	3.9	mΩ	$V_{GS} = 10V, I_D = 30A$	
Static Dialii-Source Off-Resistance	RDS(ON)	_	2.7	6	mΩ	V <sub>G</sub> S = 6V, I <sub>D</sub> = 30A	
Diode Forward Voltage	VsD	_	0.8	1.3	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 30A	
DYNAMIC CHARACTERISTICS (Note 6)							
Input Capacitance	Ciss	_	9081	_		V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V f = 1MHz	
Output Capacitance	Coss	_	556	_	pF		
Reverse Transfer Capacitance	Crss	_	80	_			
Gate Resistance	Rg	_	0.8	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	136	_		V <sub>DS</sub> = 40V, I <sub>D</sub> = 30A, V <sub>GS</sub> = 10V	
Gate-Source Charge	$Q_{gs}$	_	41	_	nC		
Gate-Drain Charge	$Q_{gd}$	_	32	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	19	_		$V_{DD} = 40V, V_{GS} = 10V$ $I_{D} = 30A, R_{G} = 2.5\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	31	_	20		
Turn-Off Delay Time	tD(OFF)	_	63	_	ns		
Turn-Off Fall Time	tF	_	27	_			
Reverse Recovery Time	t <sub>RR</sub>	_	58	_	ns I 20A di/dt 400A/v.c		
Reverse Recovery Charge	Qrr	_	114	_	nC	I <sub>F</sub> = 30A, di/dt = 100A/μs	

Notes:

- 5. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 8. Short duration pulse test used to minimize self-heating effect.



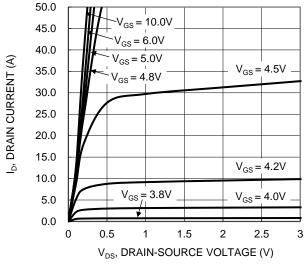


Figure 1. Typical Output Characteristic

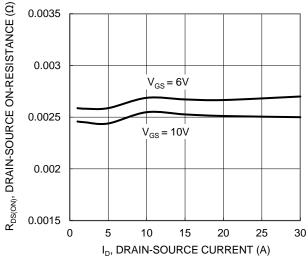


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

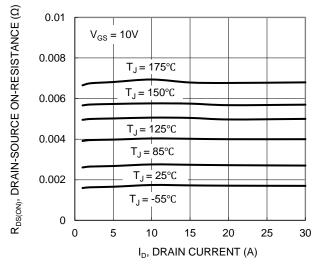


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

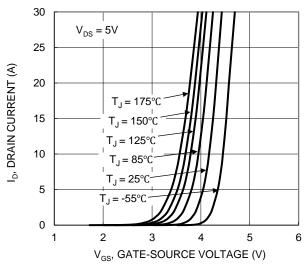


Figure 2. Typical Transfer Characteristic

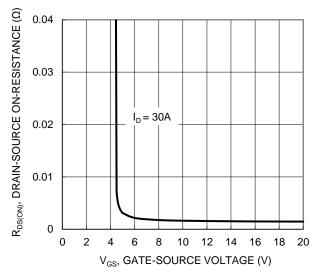


Figure 4. Typical Transfer Characteristic

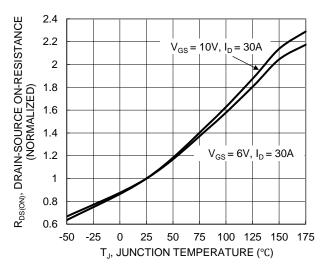


Figure 6. On-Resistance Variation with Junction Temperature



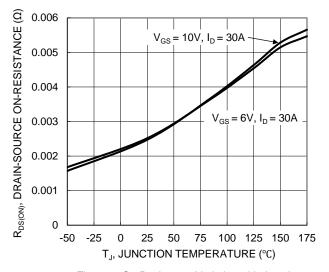
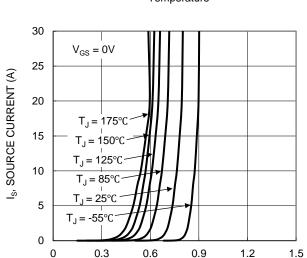
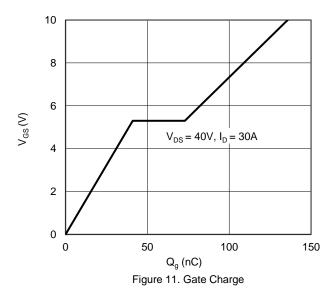


Figure 7. On-Resistance Variation with Junction Temperature



V<sub>SD</sub>, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current



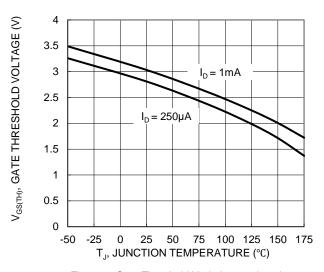


Figure 8. Gate Threshold Variation vs. Junction Temperature

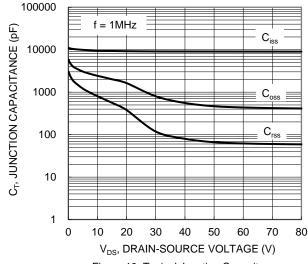
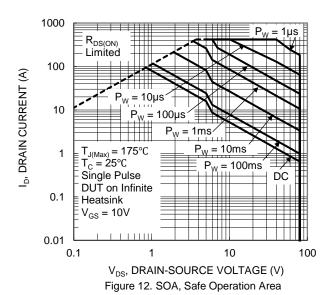


Figure 10. Typical Junction Capacitance





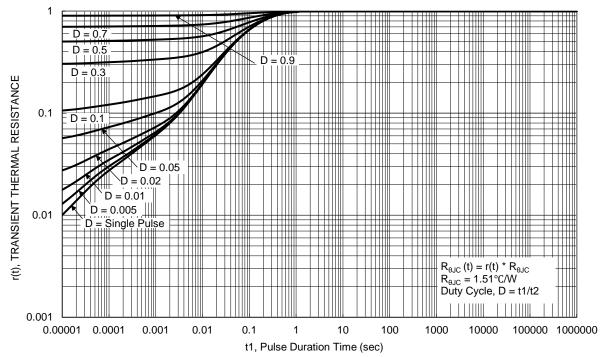


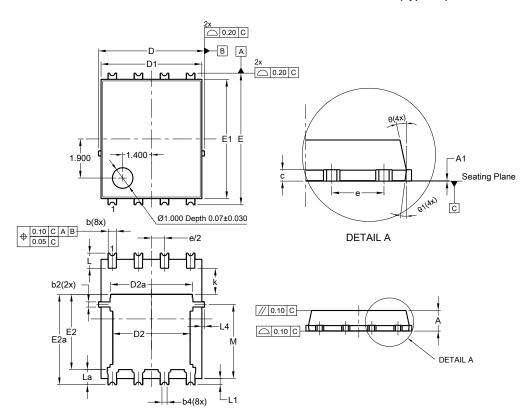
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8/SWP (Type UX)

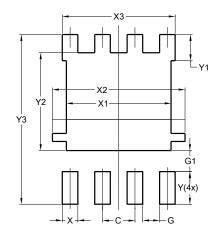


PowerDI5060-8/SWP						
(Type UX)						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
<b>A</b> 1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4		).25REF				
С	0.230	0.330	0.277			
D	5	.15 BS0	2			
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78	4.18	3.98			
Е	6	.40 BS0				
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1.27BSC					
k	1.05					
٦	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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